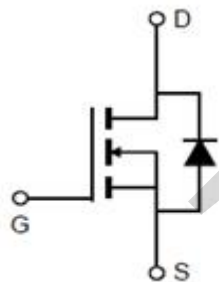
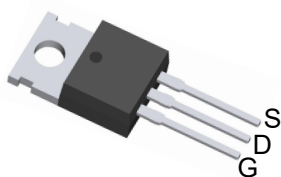


SGT N-channel Power MOSFET

**MTR10R5N10CT
TO-220CB**



V_{DS}	100	V
$R_{DS(on),TYP@ V_{GS}=10V}$	9.5	m Ω
I_D	60	A

Features

- 1、 Low on – resistance
- 2、 Package TO-220CB
- 3、 SGT N-channel Power MOSFET

Applications

- 1、 Load Switch for Portable Devices
- 2、 DC/DC Converter

Maximum ratings, at $T_A = 25^\circ\text{C}$, unless otherwise specified

Symbol	Parameter	Rating	Unit
$V_{(BR)DSS}$	Drain-Source breakdown voltage	100	V
V_{GS}	Gate-Source voltage	± 20	V
I_D	Continuous drain current @ $V_{GS}=10V$	60	A
I_S	Continuous Drain-Source Diode Forward Current	60	A
I_{DM}	Pulse drain current tested ①	$T_C=25^\circ\text{C}$ 220	A
E_{AS}	Avalanche energy, single pulsed ②	57	mJ
P_D	Maximum power dissipation	70	W
	Derating Factor above 25°C	0.56	W/ $^\circ\text{C}$
T_{STG}, T_J	Storage and Junction Temperature Range	-55 to +150	$^\circ\text{C}$

Thermal Characteristics

Symbol	Parameter	Typical	Unit
R _{θJC}	Thermal Resistance, Junction-to-Case	1.8	°C/W
R _{θJA}	Thermal Resistance, Junction-to-Ambient	62.5	°C/W

Electrical Characteristics

Symbol	Parameter	Condition	Min.	Typ.	Max.	Unit
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Static Electrical Characteristics @ T_j=25°C (unless otherwise stated)

V(BR)DSS	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =250μA	100	--	--	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =100V, V _{GS} =0V	--	--	1	μA
I _{GSS}	Gate-Body Leakage Current	V _{GS} =±20V, V _{DS} =0V	--	--	±100	nA
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250μA	2.0	3.0	4.0	V
R _{DS(on)}	Drain-Source On-State Resistance ④	V _{GS} =10V, I _D =20A	--	9.5	10.5	mΩ

Dynamic Electrical Characteristics @ T_j = 25°C (unless otherwise stated)

C _{iss}	Input Capacitance	V _{DS} =50V, V _{GS} =0V, f=1MHz	--	1680	--	pF
C _{oss}	Output Capacitance		--	271	--	pF
C _{rss}	Reverse Transfer Capacitance		--	10	--	pF
Q _g (10V)	Total Gate Charge	V _{DS} =50V, I _D =20A, V _{GS} =10V	--	37	--	nC
Q _{gs}	Gate-Source Charge		--	11	--	nC
Q _{gd}	Gate-Drain Charge		--	13	--	nC

Switching Characteristics

Td(on)	Turn-on Delay Time	V _{DS} =50V, I _D =10V, V _G =10V, R _G =5Ω	--	4.4	--	ns
Tr	Turn-on Rise Time		--	13	--	ns
Td(off)	Turn-Off Delay Time		--	29	--	ns
Tf	Turn-Off Fall Time		--	16	--	ns

Source- Drain Diode Characteristics@ T_j = 25°C (unless otherwise stated)

VSD	Forward on voltage	I _{SD} =20A, V _{GS} =0V	--	--	1.2	V
Trr	Reverse Recovery Time	I _F =30A, di/dt=100A/μs	--	168	--	ns
Qrr	Reverse Recovery Charge	I _F =30A, di/dt=100A/μs	--	388	--	nC

NOTE: ① Repetitive rating; pulse width limited by max junction temperature.

② Limited by T_{Jmax}, starting T_J = 25°C, L = 10mH. Part not recommended for use above this value

③ The power dissipation P_{DSM} is based on R_{θJA} and the maximum allowed junction temperature of 150°C.

④ Pulse width ≤ 300μs; duty cycle ≤ 2%.

Typical Characteristics

Figure 1. Typical Output Characteristics

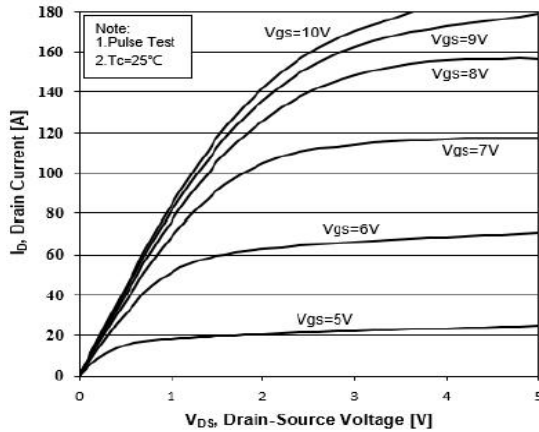


Figure 2. Maximum Continuous Drain Current vs Case Temperature

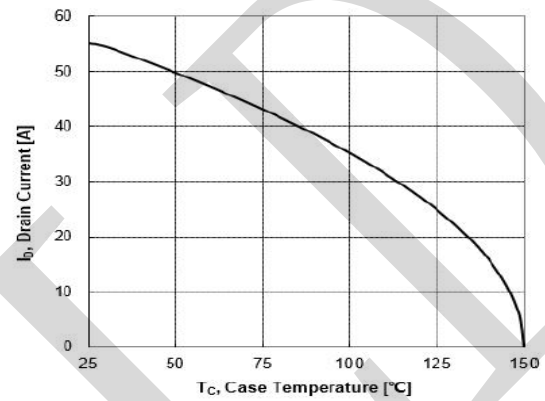


Figure 3. Typical Transfer Characteristics

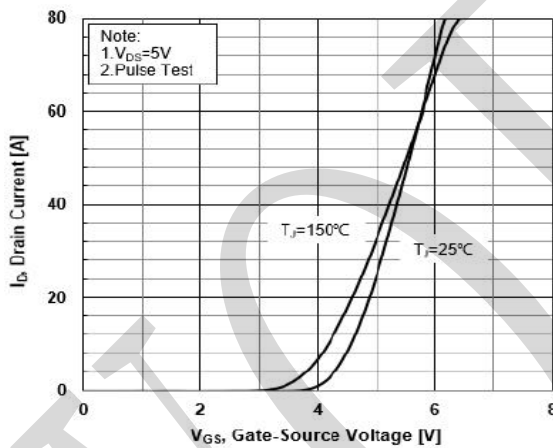


Figure 4. Typical Gate Charge vs Gate-Source Voltage

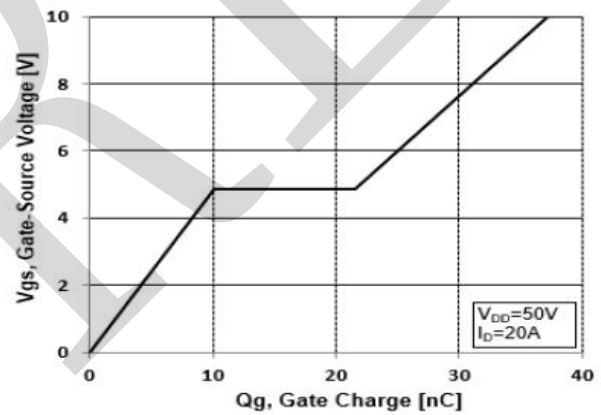


Figure 5. Normalized Threshold Voltage vs Junction Temperature

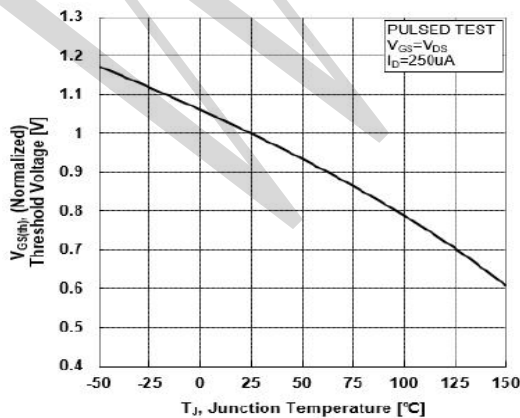
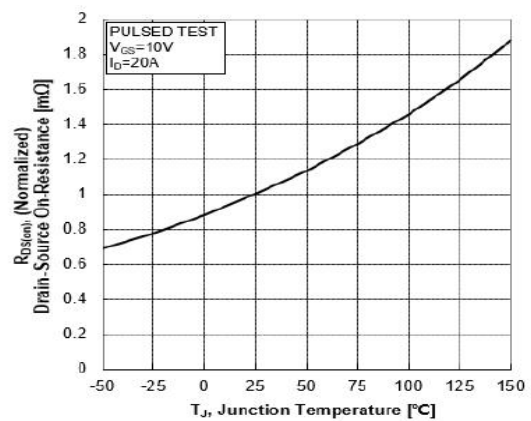


Figure 6. Normalized On-Resistance vs Junction Temperature



Typical Characteristics

Figure 7. Capacitance Characteristics

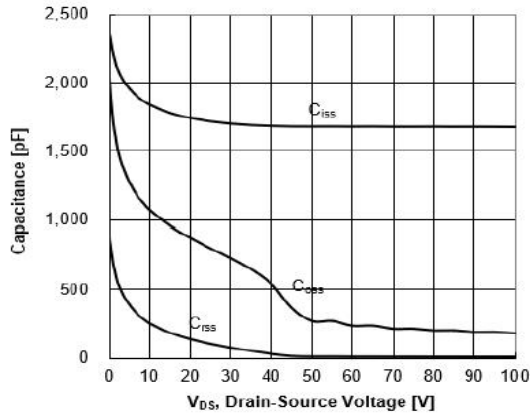


Figure 8. Safe Operating Area

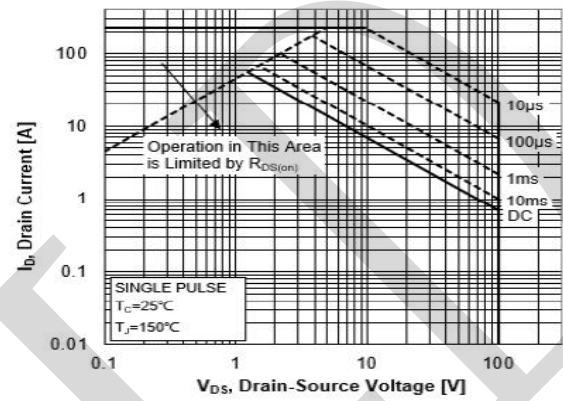


Figure 9. Drain-Source On-Resistance vs Drain Current

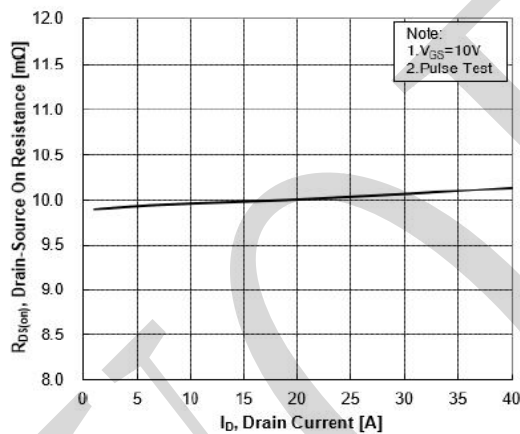


Figure 10. Source-Drain Diode Forward Characteristics

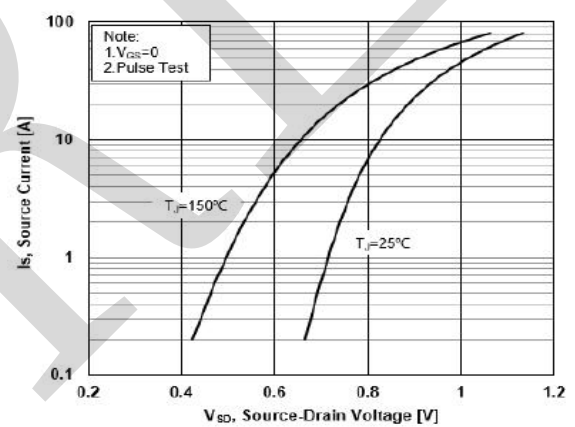


Figure 11. Maximum Power Dissipation vs Case Temperature

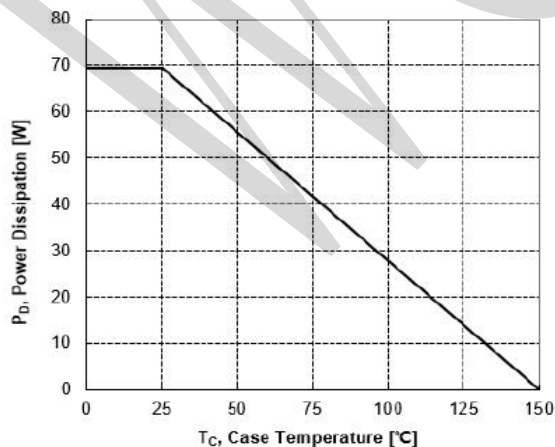
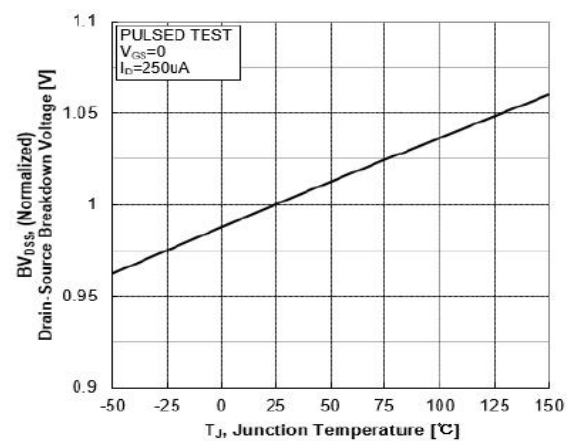
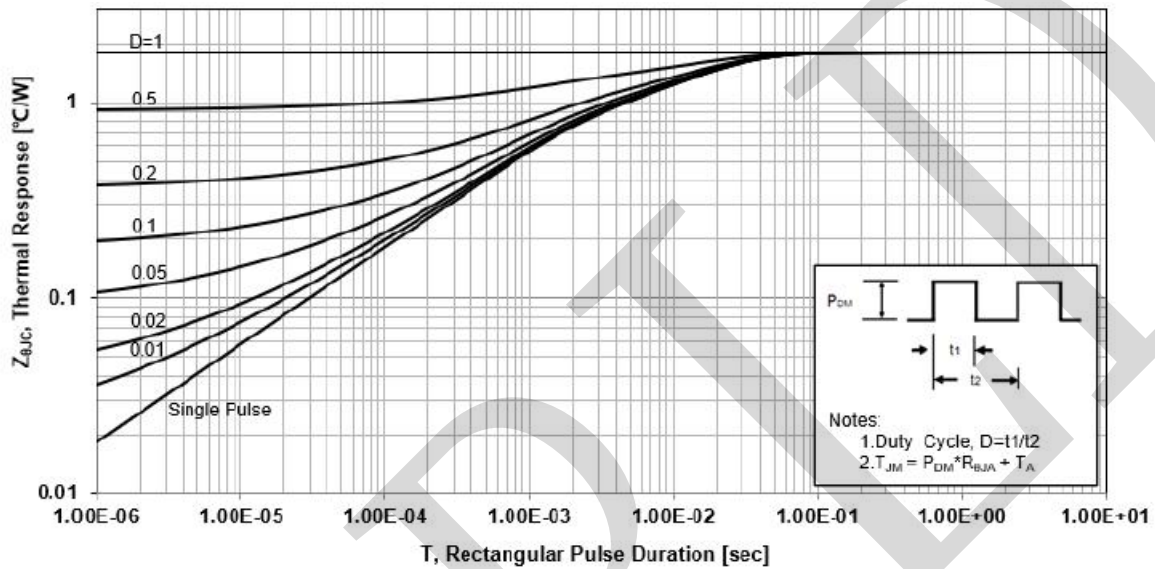


Figure 12. Normalized Breakdown Voltage vs Junction Temperature



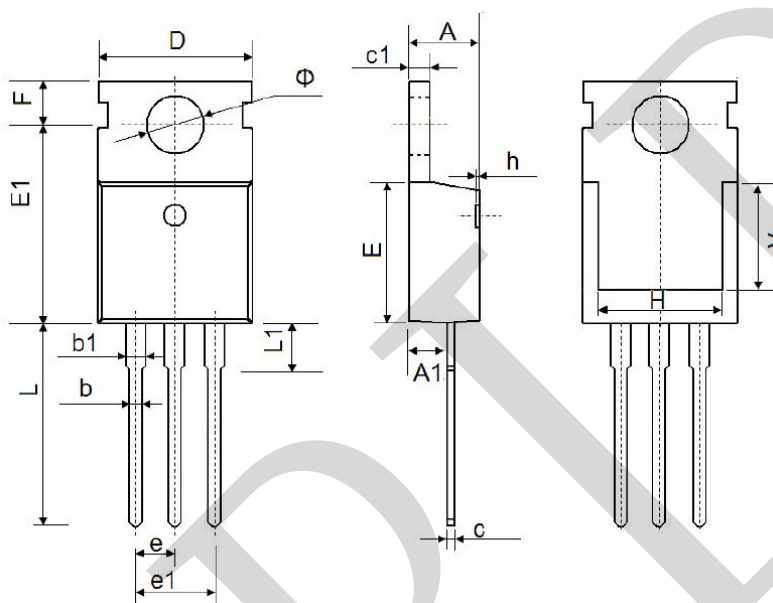
Typical Characteristics

Figure13. Transient Thermal Impedance



PACKAGE OUTLINE DIMENSIONS

TO-220CB



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	4.400	4.600	0.173	0.181
A1	2.250	2.550	0.089	0.100
b	0.710	0.910	0.028	0.036
b1	1.170	1.370	0.046	0.054
c	0.330	0.650	0.013	0.026
c1	1.200	1.400	0.047	0.055
D	9.910	10.250	0.390	0.404
E	8.9500	9.750	0.352	0.384
E1	12.650	12.950	0.498	0.510
e	2.540 Typ.		0.100 Typ.	
e1	4.980	5.180	0.196	0.204
F	2.650	2.950	0.104	0.116
H	7.900	8.100	0.311	0.319
h	0.000	0.300	0.000	0.012
L	12.900	13.400	0.508	0.528
L1	2.850	3.250	0.112	0.128
V	7.500 Ref.		0.295 Ref.	
Φ	3.400	3.800	0.134	0.150